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Dip-coating decoration of Ag₂O nanoparticles on SnO₂ nanowires for high-performance H₂S gas sensors

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 SnO_2 nanowires (NWs) are used in gas sensors, but their response to highly toxic gas H_2S is low. Thus, their performance toward the effective detection of low-level H_2S in air should be improved for environmental-pollution control and monitoring. Herein, Ag_2O nanoparticle decorated SnO_2 NWs were prepared by a simple on-chip growth and subsequent dip-coating method. The amount of decorated Ag_2O nanoparticles on the surface of SnO_2 NWs was modified by changing the concentration of Ag_2O_3 solution and/or dipping times. Gas-sensing measurements were conducted at various working temperatures ($200-400~^{\circ}C$) toward different H_2S concentrations ranging within 0.1-1 ppm. The selectivity of Ag_2O_3 -decorated SnO_2 NW sensors for ammonia and hydrogen gases was tested. Results confirmed that the Ag_2O_3 -decorated SnO_2 NW sensors had excellent response, selectivity, and reproducibility. The gas-sensing mechanism was interpreted under the light of energy-band bending by sulfurization, which converted the p-n junction into n-n, thereby significantly enhancing the sensing performance.

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1. Introduction

Air pollution caused by H2S gas is extremely dangerous even at low concentrations (sub-ppm level) because this gas is colorless, flammable, and highly toxic.1 The sources of H2S are very diverse² because it can be produced naturally from crude petroleum, oil drilling, and volcano eruption or from the bacterial decomposition of organic matter in anaerobic environments.3 H₂S is also produced as a by-product in biogas plants during waste treatment.4 The effects of H2S on the human body are summarized in Table 1.5 The threshold odor concentration of H2S is about 10 ppb, but its toxic concentration range is very broad (i.e., from ppb to ppm). The threshold limit of H₂S is reportedly 0.003 ppm for 8 h of exposure.⁵ However, the permissible concentration of H₂S recommended by the Scientific Advisory Board on Toxic Air Pollutants (USA) ranges within 20-100 ppb.6 Thus, effective gas sensors for detecting low levels of H₂S under field conditions are urgent to develop.²

Many techniques for H_2S detection have been developed, but metal oxide-based resistive-type gas sensors are advantageous because of their low cost, high sensitivity, real-time detection, portability, and low power consumption.⁷⁻¹⁰ SnO₂ (ref. 11) is one

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of the most popular materials for such sensors because of its relatively high sensitivity to various gases, as well as its feasibility in functionalization to improve sensing performance. 12,13 However, SnO2 has the main drawback of low response to low concentration of H₂S¹⁴ and poor selectivity over air-polluting gases such as NH3, H2S, and CO.15,16 This problem can be solved by using heterojunctions between two dissimilar semiconducting materials, which utilizes the unique effects and leads to enhanced sensor performance. 15 Nano-heterostructures are often utilized owing to their small size and high surface-tovolume ratio, 17,18 and many efforts have been devoted to the fabrication of p-n heterojunctions for increasing H₂S-sensing performance.19-24 The most common p-type metal oxides used to form heterojunctions with n-type SnO₂ semiconductor are CuO, 18,25 NiO, 26,27 and Co₃O₄ (ref. 24) because of their easy sulfidation into CuS, NiS, and CoS, respectively. However, sensors with these oxides can detect H2S gas only at high concentrations of >10 ppm²⁸ because the sulfidation of transition-metal oxides requires a high supply of sulfur source.29 Meanwhile, Ag2O has unique characteristics that enable it to functionalize SnO2 nanomaterials to enhance gas-sensing performance to different gases such as H2,30 ethanol,31 and CO.32 The decoration of p-type Ag₂O on the surface of n-type SnO₂ is advantage over the use of metallic Ag because it forms the p-n heterojunction, thus enhances the gas sensing performance.33-35 Ag2O is also reported easily converted into Ag₂S in the presence of H₂S³⁶ because of its low free Gibbs energy for the reaction. The free Gibbs energy for conversion of Ag₂O, CuO, and NiO into Ag₂S,

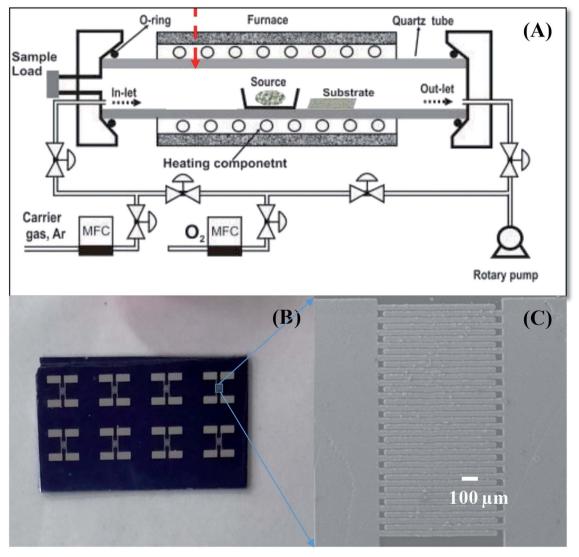
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Table 1 Effects of exposure to H₂S.⁵

Concentration (ppm)	Effects
0.003-0.02	Approximate threshold for odor
3-10	Obvious offensive odor
50-100	Serious eye irritation and respiratory tract irritation
100-200	Loss of smell
250-500	Fluid buildup in lungs and imminent threat to life
500	Anxiety, headache, dizziness, excessively rapid respiration, amnesia, and unconsciousness
500-1000	Immediate collapse, irregular heartbeat, neural paralysis, and respiratory paralysis leading to death

CuS, and NiS in the present of $\rm H_2S$ gas is -224.7, -119.1, and -62.5 kJ mol $^{-1}$, respectively. Therefore, decoration of $\rm Ag_2O$ nanoparticles on the surface of $\rm SnO_2$ is expected to show better sensing performance such as low detection limit of $\rm H_2S$ with higher sensitivity than others. However, few studies have focused on improving of $\rm H_2S$ -sensing properties using $\rm Ag_2O/SnO_2$ thin film. $^{33-35}$ It is hard to find the related work reported on

the decoration of Ag₂O on the surface of SnO₂ NWs for enhanced H₂S gas despite the significantly higher stability of NWs than their thin-film counterparts.³⁷ Doped thick films have shown good sensitivity to low concentrations of H₂S but are not feasible to miniaturize.³³ Decorated thin films present poor response to high concentrations of H₂S.³⁴ A previous work³⁵ has reported extremely low response (99%) to the high H₂S



Scheme 1 . Sensor fabrication process: (A) CVD system used to grow SnO₂ NWs, (B) photo of sensor chips; (C) SnO₂ NW sensor after fabrication.

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concentration of 50 ppm at 74 °C. Our group has recently reported the H₂S-sensing characteristics of self-heated Ag-coated SnO₂ NWs, where the decoration of Ag is realized by sputtering method.³⁸ However, this method requires vacuum conditions and expensive equipment for Ag decoration, and the content of Ag₂O nanoparticles on the surface of SnO₂ NWs are difficult to control. Thus, a low-cost, suitable, and effective method for functionalizing p-type Ag₂O nanoparticles with low activation energy for reversible sulfidation and oxidation, as well as enhanced H₂S-sensing performance of SnO₂ NWs, must be developed.

Herein, we reported the dip-coating decoration of Ag₂O nanoparticles on the surface of on-chip-grown SnO₂ NWs to enhance their H₂S gas-sensing performance. Decoration was realized by dipping the sensor in AgNO₃ solution, followed by oxidation to form Ag₂O nanocrystals on the surface of SnO₂ NWs. The effects of Ag₂O content on the H₂S gas-sensing performance of the SnO₂ NWs were studied to maximize sensor response to H₂S. Results demonstrated that the sensors processed excellent performance for monitoring extremely low H₂S concentrations. The H₂S gas-sensing mechanism of the SnO₂ NWs functionalized with Ag₂O nanoparticles was also discussed through the perspective of band-structure and sulfurization process.

Experimental

The preparation of SnO₂ NWs-based sensors has been described in our previous publication.14 The NW sensors were directly grown on thermally oxidized silicon substrate using a chemical vapor deposition system, as shown in Scheme 1(A).³⁹ In a typical procedure, SnO2 NWs were grown on seeded Pt electrodes at 750 °C from a starting material of Sn powder through thermal evaporation. Growth proceeded at 750 °C for 20 min with an oxygen gas flow of 0.5 sccm and pressure of 1.8×10^{-1} torr. For one batch of fabrication, up to 8 sensors were obtained, as shown in Scheme 1(B). The SnO2 NWs were homogenously grown on the Pt electrode fingers, as shown in Scheme 1(C). The bare SnO₂ NWs sensors were decorated with Ag₂O nanoparticles by dip coating in AgNO₃ solutions and subsequent annealing at 500 °C for 3 h in air. This decoration method had the advantage over the sputtering method of not requiring vacuum conditions.38 The density of Ag₂O nanoparticles decorated on the surface of SnO2 NWs was controlled by varying the concentration of AgNO₃ solution (0.05, 0.2, and 1 mM) and the dipping times (1, 5, and 20 times). The samples were denoted as S0, S1, S2, S3, S4, and S5 (Table 2). The morphology, chemical composition and structural characteristics of pristine and Ag₂Odecorated SnO2 NWs were investigated by scanning electron microscopy (SEM; JEOL 7600F), energy-dispersive X-ray spectroscopy (EDS), high-resolution transmission electron microscopy (HRTEM; JEOL 2100F), and X-ray diffraction (XRD; D8 Advance).3

Gas-sensing properties were measured using a SourceMeter® Keithley 2602B. Details about the gas-sensing measurement system are described elsewhere.⁴⁰ Dry air was used as reference and diluting gas. Sensor response to different

Table 2 Samples at different AgNO₃ concentrations and dipping times

Sample	AgNO ₃ concentration (mM)	Dipping times	
S0	0	0	
S1	0.05	1	
S2	0.2	1	
S3	1	1	
	1	5	
S4 S5	1	20	

 H_2S concentrations (0.1–1 ppm) at various working temperatures (200, 250, 300, 350, and 400 °C) were investigated. The selectivity among reducing gases (including ammonia and hydrogen) and the reproducibility of the sensors were also tested. During gas-sensing measurements, sensor resistance was continuously recorded, and the target gas and dry air were alternatively switched on/off. Gas response was defined as $S = R_a/R_g$ for the reducing gas H_2S , where R_a and R_g are the sensor resistances in air and in target gas, respectively.³

3. Results and discussion

3.1. Material characterization

We did not characterize all samples and instead selected sensors S1, S2, and S5 for SEM, EDS, and TEM analysis. Fig. 1(A) illustrates a SEM image of SnO₂ NWs (S1) grown on patterned Pt electrodes. Notably, the electrode finger was 20 µm wide [inset of Fig. 1(A)]. Although the gap between two electrode fingers was 20 μm, the grown SnO₂ NWs can still efficiently cover the gaps, as shown in the inset of Fig. 1(A). SnO2 NWs grew primarily on the surface of Pt electrode fingers, but their lengths were controlled sufficiently to connect between the fingers and thus act as conducting channels in the gas-sensing measurement. The average diameter of SnO₂ NWs was approximately 70 nm. The surface of pristine SnO₂ NWs was as smooth as that of the single crystal. This result was consistent with the growth of SnO2 NWs by vapor-liquid-solid mechanism.41 Herein, we did not use Au as catalyst during the growth of SnO2 NWs, so beltlike NWs were obtained at the initial state. A SnO2 NW comprises a single crystal, as reported in our previous article.14 Composition analysis of the SnO₂ NW by EDS [Fig. 1(B)] revealed the existance of O, Sn, and Pt elements. Pt was originally from the electrode, whereas O and Sn were from the SnO2 NWs.

The SEM image of SnO₂ NWs after decoration with Ag₂O nanoparticles (S2) is presented in Fig. 1(C), whose inset is a low-magnification SEM image. The electrode fingers were covered by the SnO₂ NWs. Ag₂O decoration by dip coating maintained the morphology of the SnO₂ NWs, but their surface was not as smooth as that of the pristine sample and tiny particles can be seen in the SEM images. The high-magnification SEM image revealed the presence of Ag₂O nanoparticles on the surface of SnO₂ NWs. EDS composition analysis of S2 [Fig. 1(D)] confirmed the presence of Ag at an energy of 2.98 eV despite the quantitative evaluation displaying a value of zero.

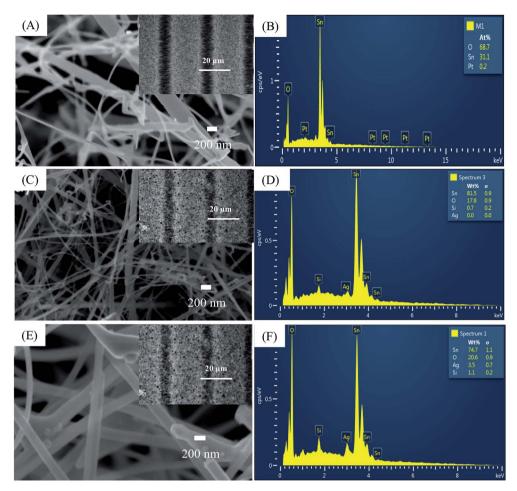


Fig. 1 SEM images and EDS analysis of: (A and B) sensor S1 (0.05 mM); (C and D) sensor S2 (0.2 mM), (E and F) sensor S5 (1 mM). Insets are correspondent sensors' fringes.

The SEM image of S5 is shown in Fig. 1(E), whose inset is a low-magnification SEM image of S5. With increased $AgNO_3$ amount in dipping solution and dipping times, the morphology of the SnO_2 NWs slightly changed. More tiny particles can be seen in the SEM image of S5, but the sample maintained its entangled NW morphology. Whether the Ag_2O nanoparticles continuously or discontinuously decorated the surface of SnO_2 NWs was difficult to observe simply by SEM observation. However, the surface of the samples was found to have increased roughness with increased Ag_2O decoration. EDS composition analysis of S5 [Fig. 1(F)] showed that the content of Ag was very high (about 3.5 wt%). This result demonstrated that increasing the concentration of $AgNO_3$ solution and the dipping times can increase the content of Ag_2O nanoparticles decorated on the surface of SnO_2 NWs for effective H_2S detection.

To further study the decoration of Ag_2O on the surface of SnO_2 NWs, we selected S1, S2, and S5 for TEM characterizations. The grown SnO_2 NWs had a very smooth and clean surface [Fig. 2(A)]. The average diameter of a SnO_2 NW was approximately 70 nm, consistently with the observation by SEM images. No Ag_2O nanoparticle was observed in this sample possibly because the $AgNO_3$ concentration of the dipping solution was too low. The HRTEM images of S2 and S5 are shown in Fig. 2(B), and (C), respectively. The black dots decorated on the SnO_2 NWs

surface were Ag₂O nanoparticles. Given that S2 was decorated by a low concentration of AgNO₃ (0.2 mM) solution, the density of Ag₂O nanoparticles on the surface of SnO₂ NWs was very low [Fig. 2(B)] and the particle sizes were about 7 nm. The size and density of Ag₂O increased with increased AgNO₃ concentration (1 mM, 20 times of dipping), as observed in S5 [Fig. 2(C)]. The diameter of Ag₂O nanoparticles decorated on the surface of SnO₂ NWs ranged within 5-20 nm. However, they were still smaller than the diameter of SnO2 NWs. The wettability of AgNO₃ solution on the SnO₂ NW surface is very important for the decoration of Ag₂O nanoparticles performed by dipping method. Wettability ensures the homogenous decoration of Ag₂O nanoparticles on the total surface of SnO₂ NWs. At a high density, Ag₂O particles may agglomerate and form a large cluster. A high-magnification HRTEM image of about 5 nm Ag₂O nanoparticle is shown in Fig. 2(D). The interspacing of \sim 0.23 nm, which corresponded to the (200) lattice plane of cubic structured Ag₂O,42 was observed. This result was consistent with a previous one on the thermal decomposition of AgNO₃ at 250–440 °C (ref. 43) into Ag. Then, Ag was oxidized into Ag₂O at an oxidation temperature of about 350-500 °C.⁴⁴ In the process of e-beam decoration, Ag nanoparticles are anisotropically decorated on one side of NWs but not homogenously.31 Herein, the wet chemical method was used to ensure

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(C) (B) 100 nm 100 nm 100 nm 5 nm

Fig. 2 TEM images of SnO_2 nanowires and SnO_2 nanowires decorated with Ag_2O nanoparticles: (A) sensor S1; (B) sensor S2, (C) sensor S5; (D) HRTEM image of Ag_2O nanoparticle on the surface of nanowire.

that nanoparticles were homogenously decorated on the surface of the NWs. Notably, S5 had larger Ag_2O nanoparticles than S2, but decoration was not continuous because overdecoration of Ag_2O nanoparticles can reduce sensor response.⁴⁵

3.2. Gas-sensing characteristics

Fig. 3(A)–(F) show the changes in transient resistance with time of S0-S5, respectively, upon exposure to various H₂S concentrations (0.1, 0.25, 0.5, and 1 ppm) measured at different working temperatures (200, 250, 300, 350, and 400 °C). So showed significant response to H2S at all measured temperatures, but the response and recovery times were very long at low working temperature [Fig. 3(A)]. At a working temperature of 200 °C, S0 required almost 1.5 h to finish one measurement at four concentrations of H2S. Thus, stair-type tests were conducted for H₂S gas sensing because of the slow recovery characteristics [Fig. 3(B)-(F)]. This finding indicated that measurements were conducted through a stepwise increase in H₂S concentration from 0.1 ppm to 1 ppm before finally being refreshed by dry air. The obtained plots illustrated that the resistance of pristine and decorated SnO2 NW sensors steeply increased when H2S gas was injected into the test chamber [Fig. 3(B)–(F)]. The resistance then recovered to the initial values

when H_2S was replaced by dry air. All these sensors presented the typical n-type gas-sensing behavior of SnO_2 NW semiconductor, where resistance decreased with increased H_2S gas exposure. The base resistance in air of pristine SnO_2 NWs (S0) was much smaller than that of Ag_2O -decorated SnO_2 sensors from S1 to S5. S5, with the largest amount of Ag_2O decoration, had the highest resistance values in air of about 7 M Ω at 200 °C. Notably, Ag_2O is also a good conductor, so the high base resistance value of S5 confirmed that the nanoparticles decorated on the surface of SnO_2 NW formed the p-n heterojunction. Based on the plot of transient resistance *versus* time of the sensors, we roughly estimated that the response values increased but the recovery rate of the sensors decreased with increased Ag_2O decoration.

The quantitative response values of different sensors are shown in Fig. 4(A)–(F). The response values of all sensors decreased with increased working temperature within the measured range. This result was similar to that of other metal-oxide-based H₂S gas sensors. ⁴⁶ The pristine SnO₂ NW sensor (S0) had the highest response value of less than 4 over all the range of working temperatures and gas concentrations [Fig. 4(A)]. The response values for 1 ppm H₂S decreased almost linearly from 3.6 to 2.9 with increased working temperature

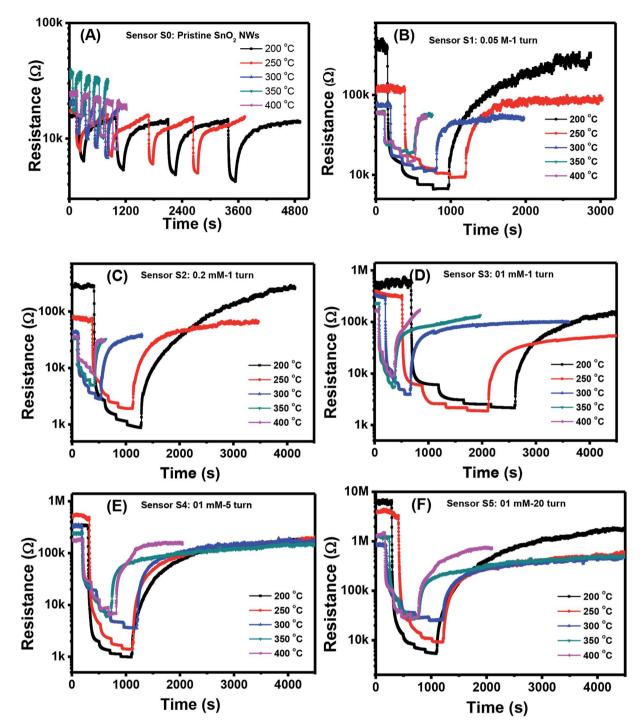


Fig. 3 Transient response to different H₂S concentrations various working temperature of the sample: SO (A), S1 (B), S2 (C), S3 (D), S4 (E), S5 (F).

from 200 °C to 400 °C. These values were very low compared with the response of Ag_2O -decorated SnO_2 NW sensors [Fig. 4(B)–(F)]. The responses of Ag_2O -decorated SnO_2 NW sensors from S1 to S5 were much higher than that of pristine SnO_2 NWs, S0. The responses of Ag_2O -decorated SnO_2 NW sensors increased with increased amount of decorated Ag_2O nanoparticles. All sensors showed better response at lower operating temperatures, reaching the highest values at 200 °C within the measured range. The response values to 1 ppm H_2S

at 200 °C of S1–S5 were approximately 61, 358, 392, 690 and 1155, respectively. The response to 1 ppm H_2S at 200 °C of S5 was about 320-fold higher than that of S0 under the same measurement condition. Notably, the maximum response to 1 ppm H_2S gas of rGO-loaded Fe_2O_3 nanofibers is only 9.2. ⁴⁶ Herein, all sensors had decreased response values with increased working temperature from 200 °C to 400 °C. The response to 0.1 ppm H_2S at 400 °C of S1 was 2.5, whereas that of S5 was much higher at about 16. Clearly, within the studied H_2S

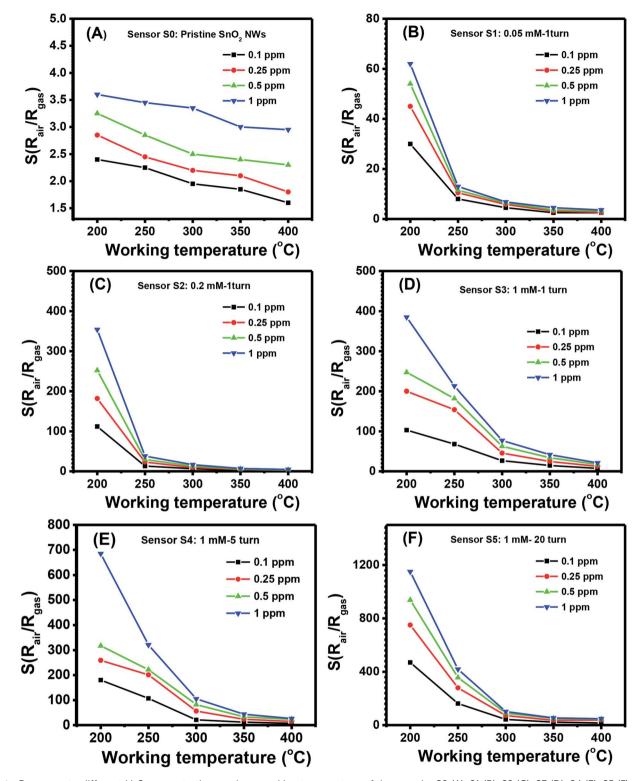


Fig. 4 Response to different H₂S concentrations various working temperature of the sample: SO (A), S1 (B), S2 (C), S3 (D), S4 (E), S5 (F).

concentration range (0.1–1 ppm), S5 had the best sensing performance because of its high sensitivity. This finding can be attributed to the p–n heterojunctions between Ag₂O nanoparticles on the surface and SnO₂ NWs,^{31,47} similar to the p–n heterojunctions between CuO and SnO₂ (ref. 19) or NiO and

SnO₂.²¹ Details about the gas-sensing mechanism are discussed in subsequent sections.

The response values of different sensors measured at 200 $^{\circ}$ C as a function of H_2S concentration are shown in Fig. 5(A). With a low content of Ag_2O decoration (S0 to S4), the response values increased almost linearly with H_2S concentration in the

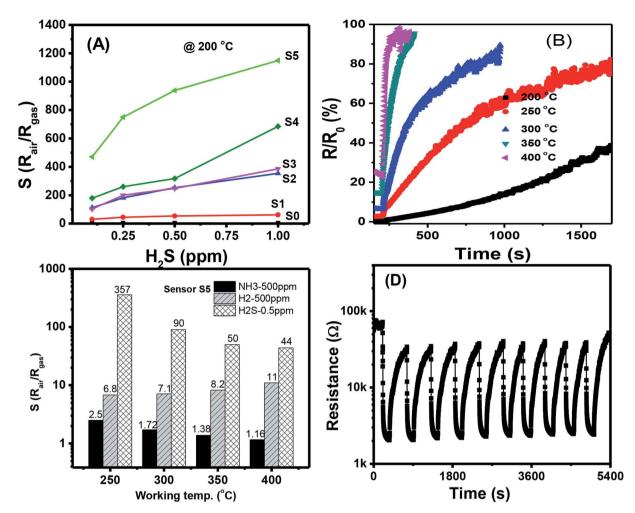


Fig. 5 (A) Comparative response of different sensors at 200 °C; (B) response time of sensor S5 measured at different temperatures; (C) response of the sensor S5 at different working temperatures to various gases; (D) stability of the sensor S5 for 10 cycles measured at 250 °C.

measured range, but their values were low. The highest response value of the sensor S0 at 200 °C for 1 ppm H₂S is about 3.7. S5 had the highest response values, and the response values increased nonlinearly with H₂S concentration. Along with the gas response, the recovery time of the sensor is very important in practical applications because it determines sensor reusability. The effects of working temperature on the recovery time of Ag₂O-decorated SnO₂ NW sensor are shown in Fig. 5(B). Obviously, the sensor had very poor recovery characteristics at low working temperatures of 200, 250, and 300 °C, i.e., resistance did not recover to the initial value after refreshing for 1000 s. However, the sensor presented 100% recovery characteristics at working temperatures of 350 and 400 °C, with a recovery time of approximately 70 s. In practical application, balance should be achieved between sensor sensitivity and recovery depending on the objective of the application. For instance, the sensors based on 2D materials have poor recovery characteristics, but they could operate at room temperature, thus suitable for low power consumption devices. 48,49 Herein, the long recovery time is possible due to the formation enthalpy of Ag₂S (-32.6 kJ mol⁻¹) is lower than that of Ag₂O

(-31 kJ mol⁻¹), thus it requires higher energy to break the bonding of Ag₂S than that of Ag₂O compound. As a result, the sensor has longer recovery time than the response time. The selectivity of S5 toward three reducing gases H₂S, NH₃, and H₂ was tested, and the results are shown in Fig. 5(C). At a low working temperature of 200 °C, the sensor did not show good recovery to H2S, so we tested the selectivity at 250, 300, 350, and 400 °C. Results demonstrated that S5 had the highest response toward 0.5 ppm H₂S despite the 1000-fold concentration in all working temperatures. At a working temperature of 400 °C, S5 still had a high response value of 44-0.5 ppm H₂S, whereas the corresponding values for 500 ppm NH₃ and 500 ppm H₂ were 1.16 and 11, respectively. Reproducibility and repeatability are also important properties of a gas sensor; thus, we tested the short-term stability of the sensor by switching on/off the ambient from air to 0.25 ppm H2S gas and back to air at a working temperature of 250 °C. As shown in Fig. 5(D), excepted for the first cycle, the sensor exhibited good recovery characteristics for 10 pulses of measurement, where the base resistance recovered to the initial value after refreshing the chamber with air. The relative standard deviation (RSD) was

Table 3 A comparative result on the functionalized-SnO₂ gas sensors for H₂S detection

Material	Conc. (ppm)	Working temp (°C)	Response (R_a/R_g)	Response/recovery times (s)	Ref.
Ag ₂ O-SnO ₂ thin film	50	74	99 ^a	>600/4500	35
CuO-SnO ₂ NWs	80	300	1280	1/828	23
NiO-SnO ₂ NWs	10	300	1372	11/102	21
CuO-SnO ₂ NWs	10	250	26.3	180/600	19
CuO-SnO ₂ nanofibers	10	150	3000	2/3000	25
CuO-SnO ₂ thin film	100	180	25.3	10/42	22
CuO-SnO ₂ hollow spheres	1	300	22.4	500/1000	50
Ag ₂ O–SnO ₂ mesoporous	1	100	71.5	390/1600	33
NiO-SnO ₂ nanoweb	100	300	~6	N/A	26
NiO-SnO ₂ thin film	10	Room	440	2000/30 000	27
Ag ₂ O-SnO ₂ NWs	0.5	_	21	12/1000	51
SnO ₂ NWs	1	_	\sim 3.5	50/200	14
Ag ₂ O-SnO ₂ NWs	1	200	1150 (S5)	350/4000	This worl
			60 (S1)	200/1500	

calculated by the equation $100 \times S/|\bar{x}|$, where S is the sample standard deviation, \bar{x} is sample mean. The RSD value of the sensor for ten pulses measurement is 92.4%, indicating the good reproducibility of the device. However, for real application, long term stability of the sensor should be studied. This work will be characterized in next step, and the data will be reported elsewhere.

For a better vision, the H_2S sensing performances of the sensors based on functionalized- SnO_2 nanomaterials are summarized in Table 3. Compared to other results in the references, our sensor showed comparable working temperature whereas was superior in response toward much lower concentration. This means that the Ag_2O decoration on the surface of SnO_2 NWs is suitable for development of high performance H_2S gas sensor.

3.3. Gas-sensing mechanism

The gas-sensing mechanism of a metal oxide-based sensor is determined by the surface reaction of the analyzed gas molecule

and pre-adsorbed oxygen species. When SnO_2 was exposed to air, atmospheric oxygen molecules were adsorbed on the surface of SnO_2 NWs to form oxygen ions $(O_2^-, O^-, and O^{2-})$ by withdrawing electrons from the conduction band of SnO_2 , as shown in the following eqn (1)–(3):

$$O_{2(gas)} + e^- \leftrightarrow O_{2(ads)}$$
 (1)

$$O_2^- + e^- \leftrightarrow 2O^-$$
 (2)

$$O^- + e^- \leftrightarrow O^{2-} \tag{3}$$

As shown in the above equations, the resistance of SnO_2 in air increased because of the formation of a thick conduction-depletion region. When air was replaced by H_2S , the oxygen ions reacted with H_2S to form SO_2 and H_2O and then released electrons back to the conduction band, resulting in decreased SnO_2 resistance, as presented in eqn (4)–(6):

$$2H_2S + 3O_2^- \leftrightarrow 2SO_2 + 2H_2O + 6e^-$$
 (4)

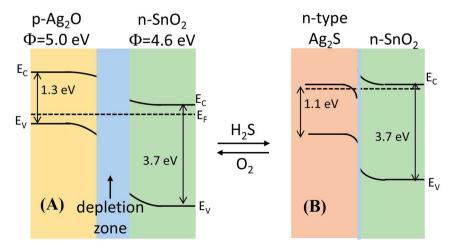


Fig. 6 Energy band diagram of the formation of the p-Ag₂O/n-SnO₂ junction in air and n-Ag₂S/n-SnO₂ in H₂S atmosphere.

$$H_2S + 3O^- \leftrightarrow SO_2 + H_2O + 3e^-$$
 (5)

$$H_2S + 3O^{2-} \leftrightarrow SO_2 + H_2O + 6e^-$$
 (6)

However, the chemophysical processes of decoration with silver and silver oxide involved in the gas-sensing properties of metal oxides can be explained in various ways. 30,52-54 The mechanisms are primarily electronic and/or chemical sensitization. The electronic mechanism is related to the extension of the electron-depleted space charge region at the interface between two materials, and the latter is related to the dominance of the dissociation of gas molecules on the surface of decorated materials by spillover effect. 53,54

Herein, we believed that the dissociation of gas molecules at Ag-based sites on the surface of Ag-decorated SnO2 facilitated the charge-transfer reaction between sensor surface and H2S molecule. The gas-sensing mechanism of Ag₂O-decorated SnO₂ NWs may involve the variation in band structure caused by the conversion of Ag₂O into Ag₂S and back to Ag₂O when the test ambient switched from air to H2S and back to air, as shown in Fig. 6(A) and (B), respectively. Ag₂O is a p-type narrow band-gap semiconductor (1.3 eV)47 with a work function of 5.0 eV,55,56 whereas SnO₂ is a n-type wide direct-band-gap (3.7 eV) semiconductor with a higher work function of 4.6 eV.⁵⁷ Given the extension of the electron-depleted region underneath Ag₂O nanoparticles on the surface of SnO2 NWs, the barrier at the interface between these two materials developed much more than usual.31 Furthermore, the formation of a continuous series of n-p-n junctions by decorating Ag₂O nanoparticles on the network of SnO₂ NWs, which prevented the electron current in SnO₂ NWs, aggravated the decrease in SnO₂ conductivity.²¹ Upon exposure to H₂S, Ag₂O was converted into Ag₂S⁵⁸ according to eqn (7).

$$Ag_2O + H_2S \leftrightarrow Ag_2S + H_2O$$
 (7)

The conversion of Ag_2O into AgS_2 occurred spontaneously because of the negative free Gibbs energy of the reaction $(-224.7 \text{ kJ mol}^{-1})$ at room temperature. Therefore, the conversion Ag_2O into Ag_2S requires less H_2S gas, thus the sensor has a lower detection limit. In addition, Ag_2S can be an n- or p-type semiconductor depending on its surrounding environment and the pressure. The monoclinic α - Ag_2S is a n-type semiconductor with a band gap of \sim 1.1 eV and a work function of 4.42 eV. Upon exposure to H_2S , the conversion of p-type Ag_2O^{58} into n-type Ag_2S destroyed the p-n junctions of Ag_2O - SnO_2 and formed the n-n of Ag_2S - SnO_2 , resulting in largely decreased resistance [Fig. 6(B)]. Ag_2S was then re-oxidized when the sensor was in air and the p-n junctions were re-established, and the sensor resistance thus recovered to its initial value. Hence, the functionalization of silver on the surface of SnO_2 NWs improved their H_2S -sensing properties.

4. Conclusion

We introduced a dip-coating method of decorating Ag₂O nanoparticles on the surface of on-chip-grown SnO₂ NW sensors

toward $\rm H_2S$ gas monitoring. The effect of $\rm Ag_2O$ nanoparticles decorated on the surface of $\rm SnO_2$ NWs on $\rm H_2S$ gas-sensing performance was investigated. $\rm SnO_2$ NW sensor decorated with $\rm Ag_2O$ nanoparticles illustrated the highest response of 1150 to 1 ppm $\rm H_2S$ at a working temperature of 200 °C with reasonable response and recovery time. Selectivity tests over high concentrations of $\rm NH_3$ (500 ppm) and $\rm H_2$ (500 ppm) at various working temperatures presented excellent response, selectivity, and reproducibility, demonstrating the sensor's potential application in the selective monitoring of low-level $\rm H_2S$ gas. The high performance of the sensor was also confirmed under the light of sulfurization, which turned the band structure from p–n of $\rm Ag_2O$ – $\rm SnO_2$ into n–n of $\rm Ag_2S$ – $\rm SnO_2$.

Conflicts of interest

The authors hereby declare that they have no conflict of interests regarding the publication of this paper.

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